



Integrated  
Circuit  
Systems, Inc.

# PRELIMINARY

## ICS853052

### DUAL LVCMOS / LVTTTL-TO-DIFFERENTIAL 2.5V, 3.3V, 5V LVPECL MULTIPLEXER

#### GENERAL DESCRIPTION

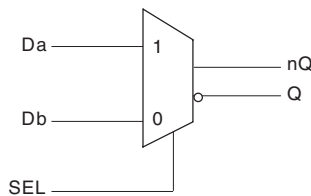


The ICS853052 is a Dual LVCMOS / LVTTTL-to-Differential 2.5V, 3.3V, 5V LVPECL Multiplexer and a member of the HiPerClocks™ family of High Performance Clocks Solutions from ICS. The ICS853052 has two selectable single ended clock inputs. The single ended clock input accepts LVCMOS or LVTTTL input levels and translates them to 2.5V, 3.3V or 5V LVPECL levels. The small outline 8-pin TSSOP or 8-pin SOIC packages make this device ideal for applications where space, high performance and low power are important.

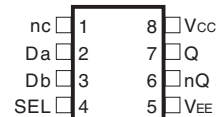
#### FEATURES

- 1 differential 2.5V, 3.3V or 5V LVPECL output
- 2 selectable LVCMOS/LVTTTL clock inputs
- Output frequency: TBD
- Additive phase jitter, RMS: 0.06ps (typical)
- Propagation Delay: 370ps (typical)
- 2.5V, 3.3V or 5V operating supply voltage (operating range 2.375V to 5.5V)
- -40°C to 85°C ambient operating temperature
- Pin compatible with MC100EP58

#### BLOCK DIAGRAM



#### PIN ASSIGNMENT



#### ICS853052

##### 8-Lead TSSOP, 118 mil

3mm x 3mm x 0.95mm package body

##### G Package

Top View

##### 8-Lead SOIC, 150 mil

3.90mm x 4.90mm x 1.37mm package body

##### M Package

Top View

The Preliminary Information presented herein represents a product in prototyping or pre-production. The noted characteristics are based on initial product characterization. Integrated Circuit Systems, Incorporated (ICS) reserves the right to change any circuitry or specifications without notice.



**TABLE 1. PIN DESCRIPTIONS**

Number	Name	Type		Description
1	nc	Unused		No connect.
2, 3	Da, Db	Input	Pulldown	LVCMOS / LVTTTL clock inputs.
4	SEL	Input	Pulldown	Select input pin. When HIGH, selects Da input clock. When Low selects Db input clock. Single-ended 100H LVPECL interface levels.
5	V <sub>EE</sub>	Power		Negative supply pin.
6, 7	nQ, Q	Output		Differential output pair. LVPECL interface levels.
8	V <sub>CC</sub>	Power		Positive supply pin.

NOTE: *Pulldown* refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

**TABLE 2. PIN CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C <sub>IN</sub>	Input Capacitance			1		pF
R <sub>PULLDOWN</sub>	Input Pulldown Resistor			75		KΩ

**TABLE 3. CONTROL INPUT FUNCTION TABLE**

Inputs	
SEL	Selected Source
0	Db
1	Da



**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, $V_{CC}$	6V (LVPECL mode, $V_{EE} = 0$ )
Negative Supply Voltage, $V_{EE}$	-6V (ECL mode, $V_{CC} = 0$ )
Inputs, $V_I$ (LVPECL mode)	-0.5V to $V_{CC} + 0.5V$
Inputs, $V_I$ (ECL mode)	0.5V to $V_{EE} - 0.5V$
Outputs, $I_O$	
Continuous Current	50mA
Surge Current	100mA
Operating Temperature Range, $T_A$	-40°C to +85°C
Storage Temperature, $T_{STG}$	-65°C to 150°C
Package Thermal Impedance, $\theta_{JA}$ (Junction-to-Ambient)	101.7°C/W (0 m/s) TSSOP 112.7°C/W (0 lfpm) SOIC

**NOTE:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

**TABLE 4A. DC CHARACTERISTICS,  $V_{CC} = 2.5V$ ;  $V_{EE} = 0V$**

Symbol	Parameter	-40°C			25°C			85°C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Power Supply Current		21			21			21		mA
$V_{OH}$	Output High Voltage; NOTE 1	1.375	1.475	1.58	1.425	1.495	1.57	1.495	1.53	1.565	V
$V_{OL}$	Output Low Voltage; NOTE 1	0.605	0.745	0.88	0.625	0.72	0.815	0.64	0.735	0.83	V
$V_{IH}$	Input High Voltage, Single-Ended	1.275		1.56	1.275		1.56	1.275		-0.83	V
$V_{IL}$	Input Low Voltage, Single-Ended	0.63		0.965	0.63		0.965	0.63		0.965	V
$I_{IH}$	Input High Current			150			150			150	μA
$I_{IL}$	Input Low Current	150			150			150			μA

Input and output parameters vary 1:1 with  $V_{CC}$ .  
NOTE 1: Outputs terminated with 50Ω to  $V_{CC} - 2V$ .

**TABLE 4B. DC CHARACTERISTICS,  $V_{CC} = 3.3V$ ;  $V_{EE} = 0V$**

Symbol	Parameter	-40°C			25°C			85°C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Power Supply Current		21			21			21		mA
$V_{OH}$	Output High Voltage; NOTE 1	2175	2275	2380	2225	2295	2370	2295	2330	2365	mV
$V_{OL}$	Output Low Voltage; NOTE 1	1405	1545	1680	1425	1520	1615	1440	1535	1630	mV
$V_{IH}$	Input High Voltage), (Single-Ended)	2075		2420	2075		2420	2075		2420	mV
$V_{IL}$	Input Low Voltage, (Single-Ended)	1355		1675	1355		1675	1355		1675	mV
$I_{IH}$	Input High Current			150			150			150	μA
$I_{IL}$	Input Low Current	150			150			150			μA

Input and output parameters vary 1:1 with  $V_{CC}$ .  
NOTE 1: Outputs terminated with 50Ω to  $V_{CC} - 2V$ .



**TABLE 4C. DC CHARACTERISTICS,  $V_{CC} = 5V$ ;  $V_{EE} = 0V$**

Symbol	Parameter	-40°C			25°C			85°C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Power Supply Current		21			21			21		mA
$V_{OH}$	Output High Voltage; NOTE 1	3875	3975	4105	4080	3925	3995	4070	3995	4065	mV
$V_{OL}$	Output Low Voltage; NOTE 1	3105	3245	3380	3125	3220	3315	3140	3235	3330	mV
$V_{IH}$	Input High Voltage, Single-Ended	3775		4120	3775		4120	3775		4120	mV
$V_{IL}$	Input Low Voltage, Single-Ended	3055		3375	3055		3375	3055		3375	mV
$I_{IH}$	Input High Current			150			150			150	μA
$I_{IL}$	Input Low Current	150			150			150			μA

Input and output parameters vary 1:1 with  $V_{CC}$ .  
NOTE 1: Outputs terminated with 50Ω to  $V_{CC} - 2V$ .

**TABLE 4D. ECL DC CHARACTERISTICS,  $V_{CC} = 0V$ ;  $V_{EE} = -5.5V$  TO  $-2.375V$**

Symbol	Parameter	-40°C			25°C			85°C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Power Supply Current		21			21			21		mA
$V_{OH}$	Output High Voltage; NOTE 1	-1125	-1025	-920	-1075	-1005	-930	-1005	-970	-935	mV
$V_{OL}$	Output Low Voltage; NOTE 1	-1895	-1755	-1620	-1875	-1780	-1685	-1860	-1765	-1670	mV
$V_{IH}$	Input High Voltage, Single-Ended	-1225		-880	-1225		-880	-1225		-880	mV
$V_{IL}$	Input Low Voltage, Single-Ended	-1945		-1625	-1945		-1625	-1945		-1625	mV
$I_{IH}$	Input High Current			150			150			150	μA
$I_{IL}$	Input Low Current	150			150			150			μA

Input and output parameters vary 1:1 with  $V_{CC}$ .  
NOTE 1: Outputs terminated with 50Ω to  $V_{CC} - 2V$ .

**TABLE 5. AC CHARACTERISTICS,  $V_{CC} = 0V$ ;  $V_{EE} = -5.5V$  TO  $-2.375V$  OR  $V_{CC} = 2.375V$  TO  $5.5V$ ;  $V_{EE} = 0V$**

Symbol	Parameter	-40°C			25°C			85°C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$f_{MAX}$	Output Frequency		TBD			TBD			TBD		GHz
$t_{PLH}$	Propagation Delay, Low to High; NOTE 1		TBD			370			TBD		ps
$t_{PHL}$	Propagation Delay, High to Low; NOTE 1		TBD			370			TBD		ps
$f_{jit}$	Buffer Additive Phase Jitter, RMS; refer to Additive Phase Jitter section		TBD			0.06			TBD		ps
$V_{PP}$	Input Voltage Swing (Differential)		TBD			TBD			TBD		ps
$t_R/t_F$	Output Rise/Fall Time 20% to 80%		TBD			180			TBD		ps

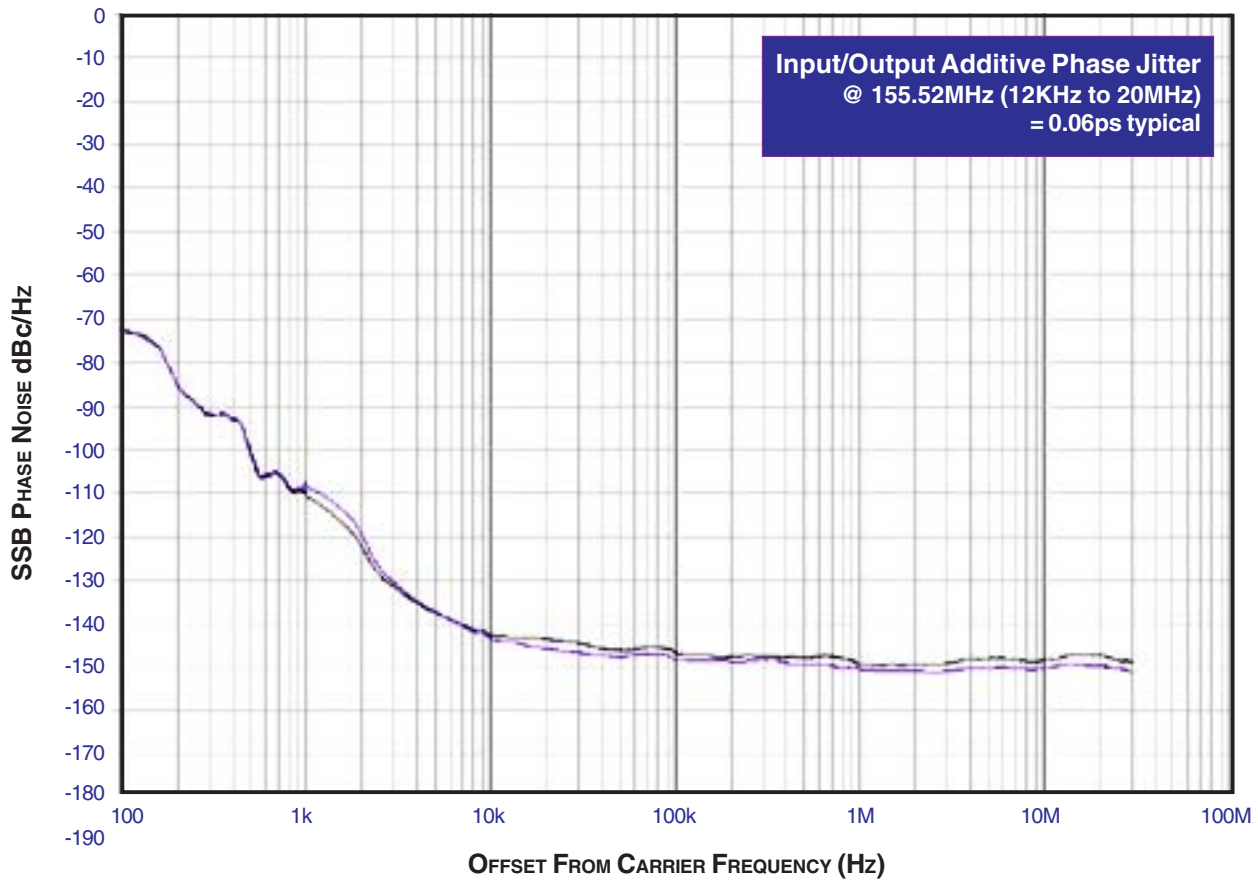
All parameters are measured  $\leq 1GHz$  unless otherwise noted.  
NOTE 1: Measured from  $V_{CC}/2$  of the input crossing point to the differential output crossing point.



### ADDITIVE PHASE JITTER

The spectral purity in a band at a specific offset from the fundamental compared to the power of the fundamental is called the **dBc Phase Noise**. This value is normally expressed using a Phase noise plot and is most often the specified plot in many applications. Phase noise is defined as the ratio of the noise power present in a 1Hz band at a specified offset from the fundamental frequency to the power value of the fundamental. This ratio is expressed in decibels (dBm) or a ratio of the power in

the 1Hz band to the power in the fundamental. When the required offset is specified, the phase noise is called a **dBc** value, which simply means dBm at a specified offset from the fundamental. By investigating jitter in the frequency domain, we get a better understanding of its effects on the desired application over the entire time record of the signal. It is mathematically possible to calculate an expected bit error rate given a phase noise plot.

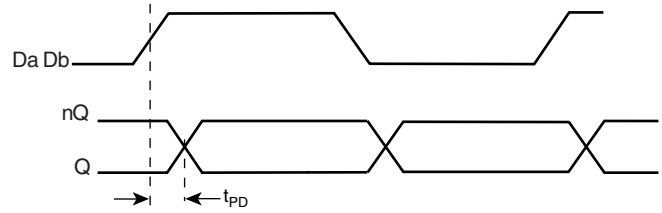
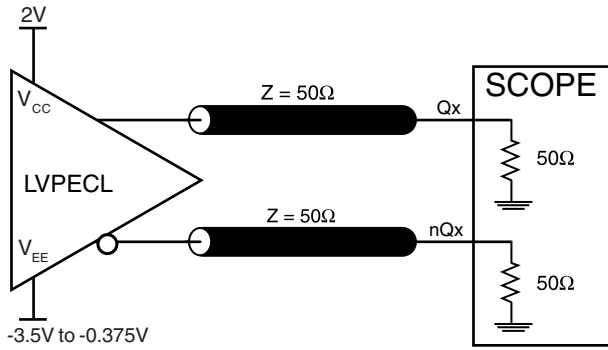


As with most timing specifications, phase noise measurements have issues. The primary issue relates to the limitations of the equipment. Often the noise floor of the equipment is higher than the noise floor of the device. This is illustrated above. The de-

vice meets the noise floor of what is shown, but can actually be lower. The phase noise is dependant on the input source and measurement equipment.

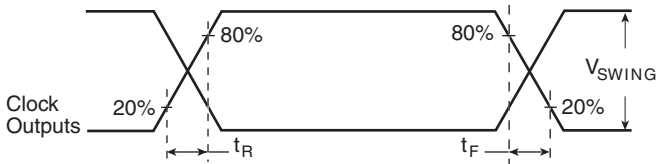


**PARAMETER MEASUREMENT INFORMATION**



**OUTPUT LOAD AC TEST CIRCUIT**

**PROPAGATION DELAY**



**OUTPUT RISE/FALL TIME**

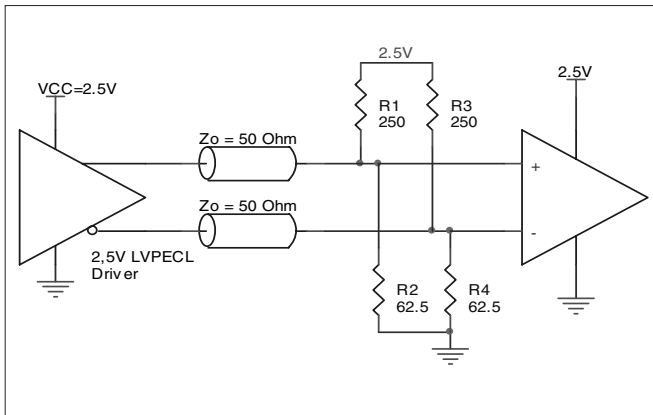


**APPLICATION INFORMATION**

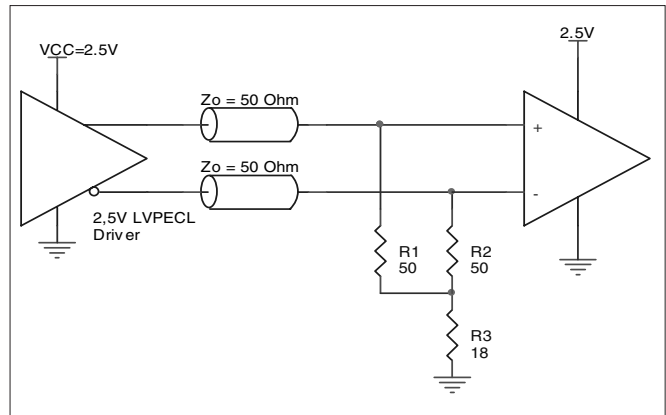
**TERMINATION FOR 2.5V LVPECL OUTPUT**

Figure 1A and Figure 1B show examples of termination for 2.5V LVPECL driver. These terminations are equivalent to terminating 50Ω to  $V_{CC} - 2V$ . For  $V_{CC} = 2.5V$ , the  $V_{CC} - 2V$  is very close to

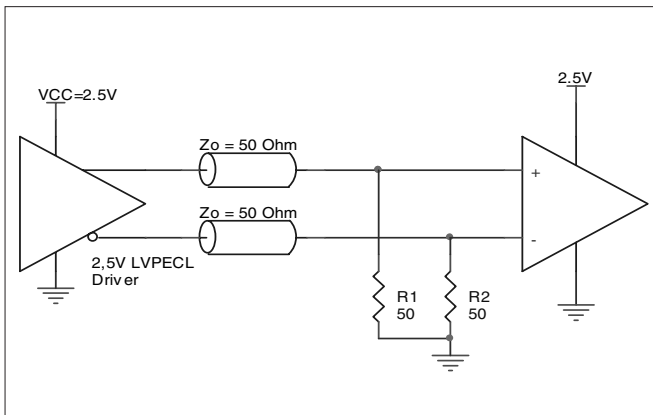
ground level. The R3 in Figure 1B can be eliminated and the termination is shown in Figure 1C.



**FIGURE 1A. 2.5V LVPECL DRIVER TERMINATION EXAMPLE**



**FIGURE 1B. 2.5V LVPECL DRIVER TERMINATION EXAMPLE**



**FIGURE 1C. 2.5V LVPECL TERMINATION EXAMPLE**

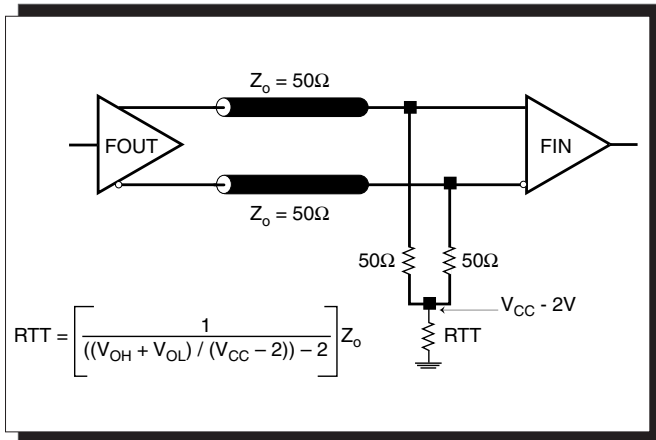


**TERMINATION FOR 3.3V LVPECL OUTPUTS**

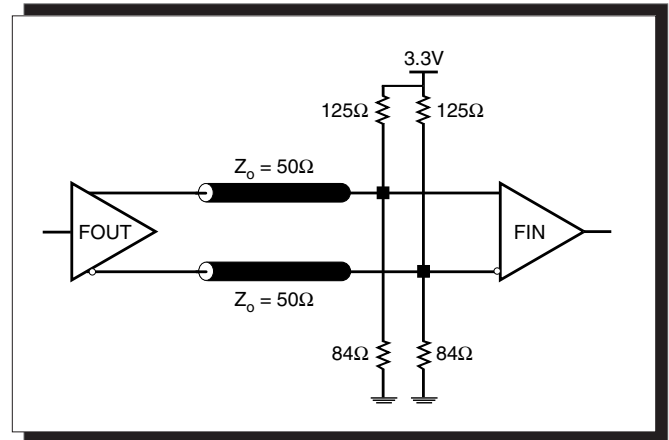
The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to drive

50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 2A and 2B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.



**FIGURE 2A. LVPECL OUTPUT TERMINATION**

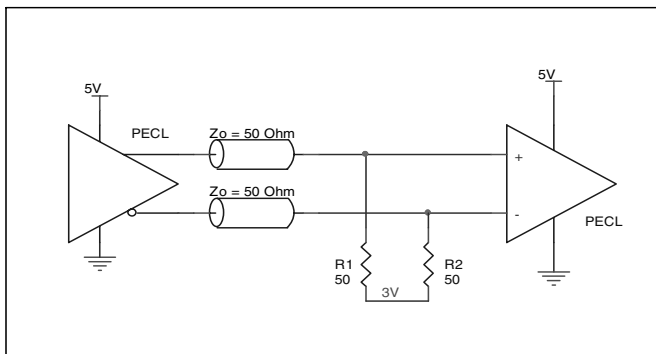


**FIGURE 2B. LVPECL OUTPUT TERMINATION**

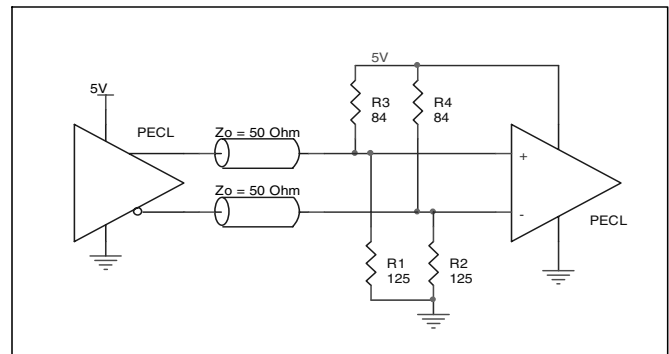
**TERMINATION FOR 5V LVPECL OUTPUT**

This section shows examples of 5V LVPECL output termination. *Figure 3A* shows standard termination for 5V LVPECL. The termination requires matched load of 50Ω resistors pull down to

$V_{CC} - 2V = 3V$  at the receiver. *Figure 3B* shows Thevenin equivalence of *Figure 3A*. In actual application where the 3V DC power supply is not available, this approach is normally used.



**FIGURE 3A. STANDARD 5V PECL OUTPUT TERMINATION**



**FIGURE 3B. 5V PECL OUTPUT TERMINATION EXAMPLE**



## POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS853052. Equations and example calculations are also provided.

### 1. Power Dissipation.

The total power dissipation for the ICS853052 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for  $V_{CC} = 5.5V$ , which gives worst case results.

**NOTE:** Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)<sub>MAX</sub> =  $V_{CC\_MAX} * I_{EE\_MAX} = 5.5V * 21mA = 115.5mW$
- Power (outputs)<sub>MAX</sub> = **30.94mW/Loaded Output pair**

$$\text{Total Power}_{MAX} (5.5V, \text{ with all outputs switching}) = 115.5mW + 30.94mW = 146.4mW$$

### 2. Junction Temperature.

Junction temperature,  $T_j$ , is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for  $T_j$  is as follows:  $T_j = \theta_{JA} * Pd\_total + T_A$

$T_j$  = Junction Temperature

$\theta_{JA}$  = Junction-to-Ambient Thermal Resistance

$Pd\_total$  = Total Device Power Dissipation (example calculation is in section 1 above)

$T_A$  = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming a moderate air flow of 1 meter per second and a multi-layer board, the appropriate value is 90.5°C/W per Table 6A below.

Therefore,  $T_j$  for an ambient temperature of 85°C with all outputs switching is:

$$85^\circ C + 0.146W * 90.5^\circ C/W = 98.2^\circ C. \text{ This is below the limit of } 125^\circ C.$$

This calculation is only an example.  $T_j$  will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

**TABLE 6A. THERMAL RESISTANCE  $\theta_{JA}$  FOR 8-PIN TSSOP, FORCED CONVECTION**

$\theta_{JA}$ by Velocity (Meters per Second)			
	0	1	2
Multi-Layer PCB, JEDEC Standard Test Boards	101.7°C/W	90.5°C/W	89.8°C/W

**TABLE 6B. THERMAL RESISTANCE  $\theta_{JA}$  FOR 8-PIN SOIC, FORCED CONVECTION**

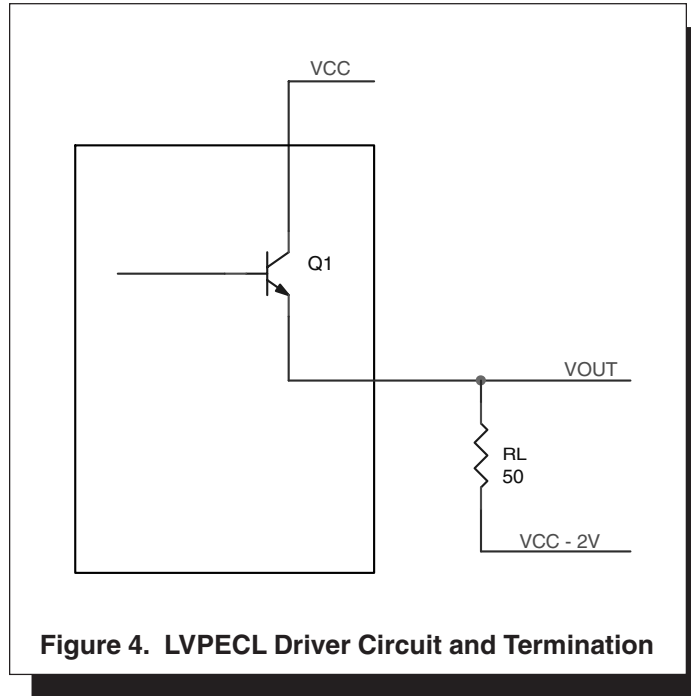
$\theta_{JA}$ by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	153.3°C/W	128.5°C/W	115.5°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	112.7°C/W	103.3°C/W	97.1°C/W

**NOTE:** Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.



3. Calculations and Equations.

LVPECL output driver circuit and termination are shown in Figure 4.



To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of  $V_{CC} - 2V$ .

- For logic high,  $V_{OUT} = V_{OH\_MAX} = V_{CC\_MAX} - 0.935V$

$$(V_{CC\_MAX} - V_{OH\_MAX}) = 0.935V$$

- For logic low,  $V_{OUT} = V_{OL\_MAX} = V_{CC\_MAX} - 1.67V$

$$(V_{CC\_MAX} - V_{OL\_MAX}) = 1.67V$$

$$Pd\_H = [(V_{OH\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CC\_MAX} - V_{OH\_MAX}))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) = [(2V - 0.935V)/50\Omega] * 0.935V = 19.92mW$$

$$Pd\_L = [(V_{OL\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CC\_MAX} - V_{OL\_MAX}))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) = [(2V - 1.67V)/50\Omega] * 1.67V = 11.02mW$$

Total Power Dissipation per output pair =  $Pd\_H + Pd\_L = 30.94mW$



**RELIABILITY INFORMATION**

**TABLE 7A.  $\theta_{JA}$  vs. AIR FLOW TABLE FOR 8 LEAD TSSOP**

$\theta_{JA}$ by Velocity (Meters per Second)			
	0	1	2
Multi-Layer PCB, JEDEC Standard Test Boards	101.7°C/W	90.5°C/W	89.8°C/W

**TABLE 7B.  $\theta_{JA}$  vs. AIR FLOW TABLE FOR 8 LEAD SOIC**

$\theta_{JA}$ by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	153.3°C/W	128.5°C/W	115.5°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	112.7°C/W	103.3°C/W	97.1°C/W

**NOTE:** Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

**TRANSISTOR COUNT**

The transistor count for ICS853052 is: 110



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DUAL LVCMOS / LVTTTL-TO-DIFFERENTIAL  
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PACKAGE OUTLINE - G SUFFIX FOR 8 LEAD TSSOP

PACKAGE OUTLINE - M SUFFIX FOR 8 LEAD SOIC

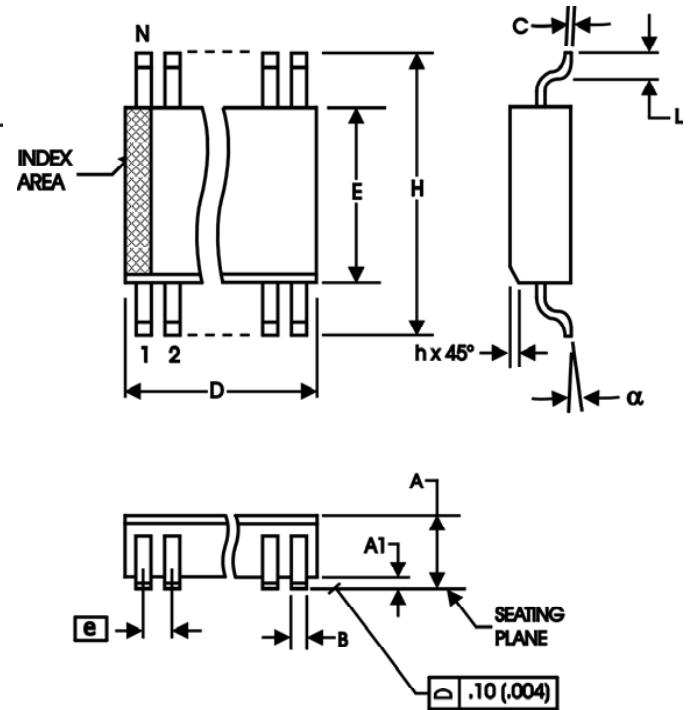
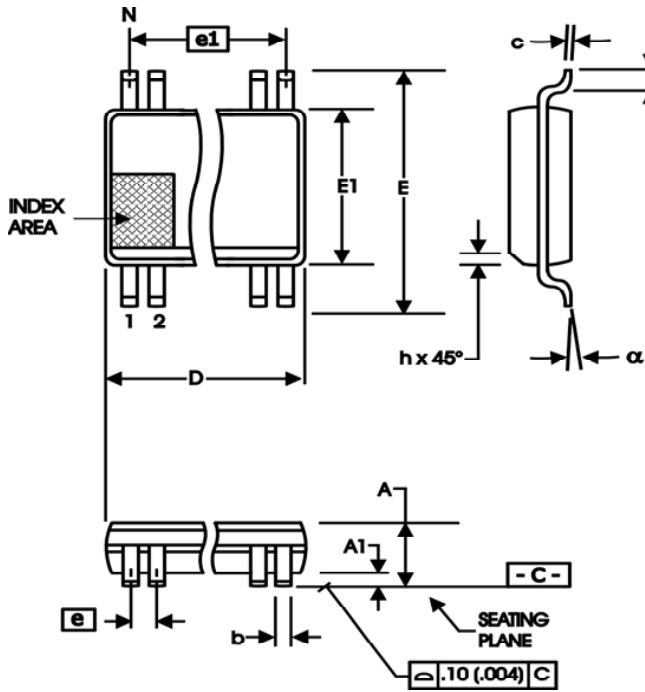


TABLE 8A. PACKAGE DIMENSIONS

SYMBOL	Millimeters	
	Minimum	Maximum
N	8	
A	--	1.10
A1	0	0.15
A2	0.79	0.97
b	0.22	0.38
c	0.08	0.23
D	3.00 BASIC	
E	4.90 BASIC	
E1	3.00 BASIC	
e	0.65 BASIC	
e1	1.95 BASIC	
L	0.40	0.80
$\alpha$	0°	8°
aaa	--	0.10

Reference Document: JEDEC Publication 95, MO-187

TABLE 8B. PACKAGE DIMENSIONS

SYMBOL	Millimeters	
	MINIMUM	MAXIMUM
N	8	
A	1.35	1.75
A1	0.10	0.25
B	0.33	0.51
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BASIC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.27
$\alpha$	0°	8°

Reference Document: JEDEC Publication 95, MS-012



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**PRELIMINARY**

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**TABLE 9. ORDERING INFORMATION**

Part/Order Number	Marking	Package	Count	Temperature
ICS853052AG	052A	8 lead TSSOP	96 per tube	-40°C to 85°C
ICS853052AGT	052A	8 lead TSSOP on Tape and Reel	2500	-40°C to 85°C
ICS853052AM	853052A	8 lead SOIC	96 per tube	-40°C to 85°C
ICS853052AMT	853052A	8 lead SOIC on Tape and Reel	2500	-40°C to 85°C

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